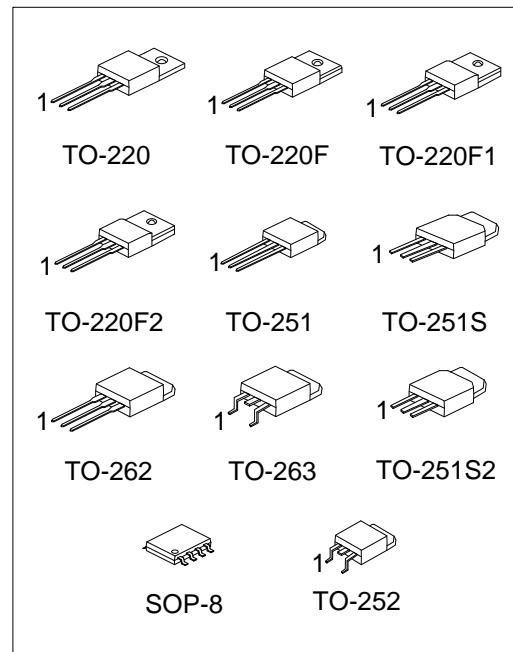
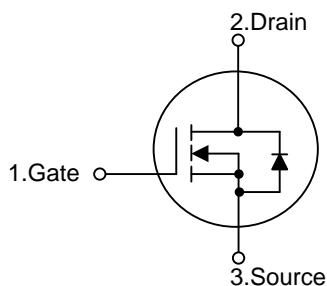


10NM70**Power MOSFET****10A, 700V N-CHANNEL
SUPER-JUNCTION MOSFET****■ DESCRIPTION**

The **UTC 10NM70** is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at AC-DC converters for power applications.

■ FEATURES

- * $R_{DS(ON)} \leq 0.6 \Omega$ @ $V_{GS}=10V$, $I_D=5.0A$
- * By using Super Junction Structure
- * Fast Switching
- * With 100% Avalanche Tested

**■ SYMBOL**

■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment								Packing
Lead Free	Halogen Free		1	2	3	4	5	6	7	8	
10NM70L-TA3-T	10NM70G-TA3-T	TO-220	G	D	S	-	-	-	-	-	Tube
10NM70L-TF1-T	10NM70G-TF1-T	TO-220F1	G	D	S	-	-	-	-	-	Tube
10NM70L-TF2-T	10NM70G-TF2-T	TO-220F2	G	D	S	-	-	-	-	-	Tube
10NM70L-TF3-T	10NM70G-TF3-T	TO-220F	G	D	S	-	-	-	-	-	Tube
10NM70L-TM3-T	10NM70G-TM3-T	TO-251	G	D	S	-	-	-	-	-	Tube
10NM70L-TMS-T	10NM70G-TMS-T	TO-251S	G	D	S	-	-	-	-	-	Tube
10NM70L-TMS2-T	10NM70G-TMS2-T	TO-251S2	G	D	S	-	-	-	-	-	Tube
10NM70L-TN3-R	10NM70G-TN3-R	TO-252	G	D	S	-	-	-	-	-	Tape Reel
10NM70L-T2Q-T	10NM70G-T2Q-T	TO-262	G	D	S	-	-	-	-	-	Tube
10NM70L-TQ2-T	10NM70G-TQ2-T	TO-263	G	D	S	-	-	-	-	-	Tube
10NM70L-TQ2-R	10NM70G-TQ2-R	TO-263	G	D	S	-	-	-	-	-	Tape Reel
10NM70L-S08-R	10NM70G-S08-R	SOP-8	S	S	S	G	D	D	D	D	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

 (1)Packing Type (2)Package Type (3)Green Package	(1) T: Tube, R: Tape Reel (2) TA3: TO-220, TF3: TO-220F, TF1: TO-220F1, TF2: TO-220F2, TM3: TO-251, TMS: TO-251S TMS2: TO-251S2, TN3: TO-252, T2Q: TO-262 S08: SOP-8 (3) G: Halogen Free and Lead Free, L: Lead Free
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■ MARKING

TO-220 / TO-220F / TO-220F1 TO-220F2 / TO-251 / TO-251S TO-251S2 / TO-252 / TO-262 / TO-263	SOP-8
 Lot Code ←	 Date Code → L: Lead Free → G: Halogen Free → Lot Code →

■ **ABSOLUTE MAXIMUM RATINGS** ($T_C = 25^\circ\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain to Source Voltage		V_{DSS}	700	V
Gate to Source Voltage		V_{GSS}	± 30	V
Continuous Drain Current	Continuous	I_D	10	A
Pulsed Drain Current	Pulsed (Note 2)	I_{DM}	40	A
Avalanche Current		I_{AR}	3.8	A
Avalanche Energy	Single Pulsed (Note 3)	E_{AS}	72	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	3.5	V/ns
Power Dissipation	TO-220/TO-262	P_D	84	W
	TO-263		29	W
	TO-220F/TO-220F1		58	W
	TO-220F2		1.5	W
	TO-251/TO-251S2		+150	$^\circ\text{C}$
Junction Temperature		T_J	-55 ~ +150	$^\circ\text{C}$
Storage Temperature		T_{STG}		

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.
 Absolute maximum ratings are stress ratings only and functional device operation is not implied.
 2. Repetitive Rating : Pulse width limited by maximum junction temperature.
 3. L=10mH, $I_{AS}=3.8\text{A}$, $V_{DD}=50\text{V}$, $R_G=25\Omega$, Starting $T_J=25^\circ\text{C}$.
 4. $I_{SD} \leq 10\text{A}$, $di/dt \leq 200\text{A}/\mu\text{s}$, $V_{DD} \leq BV_{DSS}$, Starting $T_J=25^\circ\text{C}$.

■ **THERMAL DATA**

PARAMETER		SYMBOL	RATING	UNIT
Junction to Ambient	TO-220/TO-220F	θ_{JA}	62.5	$^\circ\text{C/W}$
	TO-220F1/TO-220F2		125 (Note)	
	TO-262/TO-263		110	
	SOP-8			
	TO-251/TO-251S2			
Junction to Case	TO-251S/TO-252	θ_{JC}		$^\circ\text{C/W}$
	TO-220/TO-262		1.48	
	TO-263		5.95	
	TO-220F/TO-220F1		2.15 (Note)	
	TO-220F2		83.3 (Note)	
TO-251/TO-251S2				
TO-251S/TO-252				
SOP-8				

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

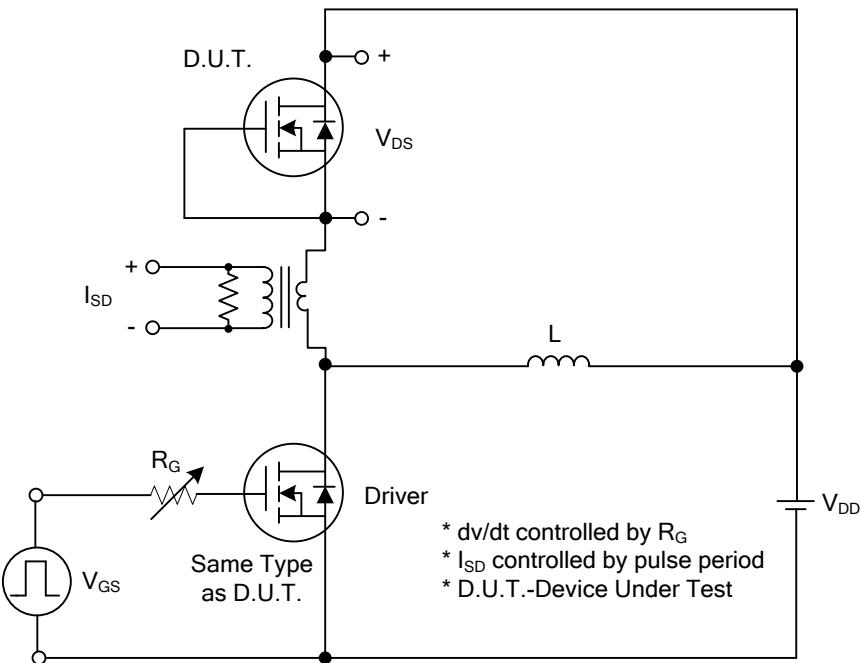
■ **ELECTRICAL CHARACTERISTICS** ($T_J = 25^\circ\text{C}$, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	700			V
Drain-Source Leakage Current	I_{DSS}	$V_{\text{DS}}=700\text{V}, V_{\text{GS}}=0\text{V}$			10	μA
Gate-Source Leakage Current	I_{GSS}	$V_{\text{DS}}=0\text{V}, V_{\text{GS}}=\pm 30\text{V}$			± 100	nA
ON CHARACTERISTICS						
Gate Threshold Voltage	$V_{\text{GS}(\text{TH})}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	2.5		4.5	V
Drain-Source On-State Resistance	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=5.0\text{A}$			0.6	Ω
DYNAMIC PARAMETERS						
Input Capacitance	C_{ISS}	$V_{\text{DS}}=25\text{V}, V_{\text{GS}}=0\text{V}, f=1.0\text{MHz}$		660		pF
Output Capacitance	C_{OSS}			400		pF
Reverse Transfer Capacitance	C_{RSS}			35		pF
SWITCHING PARAMETERS						
Total Gate Charge (Note 1)	Q_G	$V_{\text{DS}}=560\text{V}, V_{\text{GS}}=10\text{V}$ $I_{\text{D}}=10\text{A}, I_{\text{G}}=1\text{mA}$ (Note 1,2)		24		nC
Gate to Source Charge	Q_{GS}			4.6		nC
Gate to Drain Charge	Q_{GD}			8.1		nC
Turn-ON Delay Time (Note 1)	$t_{\text{D}(\text{ON})}$	$V_{\text{DD}}=100\text{V}, V_{\text{GS}}=10\text{V},$ $I_{\text{D}}=10\text{A}, R_{\text{G}}=25\Omega$ (Note 1, 2)		9		ns
Rise Time	t_R			21		ns
Turn-OFF Delay Time	$t_{\text{D}(\text{OFF})}$			70		ns
Fall-Time	t_F			46		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS						
Maximum Body-Diode Continuous Current	I_S				10	A
Maximum Body-Diode Pulsed Current	I_{SM}				40	A
Drain-Source Diode Forward Voltage (Note 1)	V_{SD}	$I_S=10\text{A}, V_{\text{GS}}=0\text{V}$			1.4	V
Body Diode Reverse Recovery Time (Note 1)	t_{rr}	$I_S=10\text{A}, V_{\text{GS}}=0\text{V}$		420		ns
Body Diode Reverse Recovery Charge	Q_{rr}	$dI_F/dt=100\text{A}/\mu\text{s}$		5.44		μC

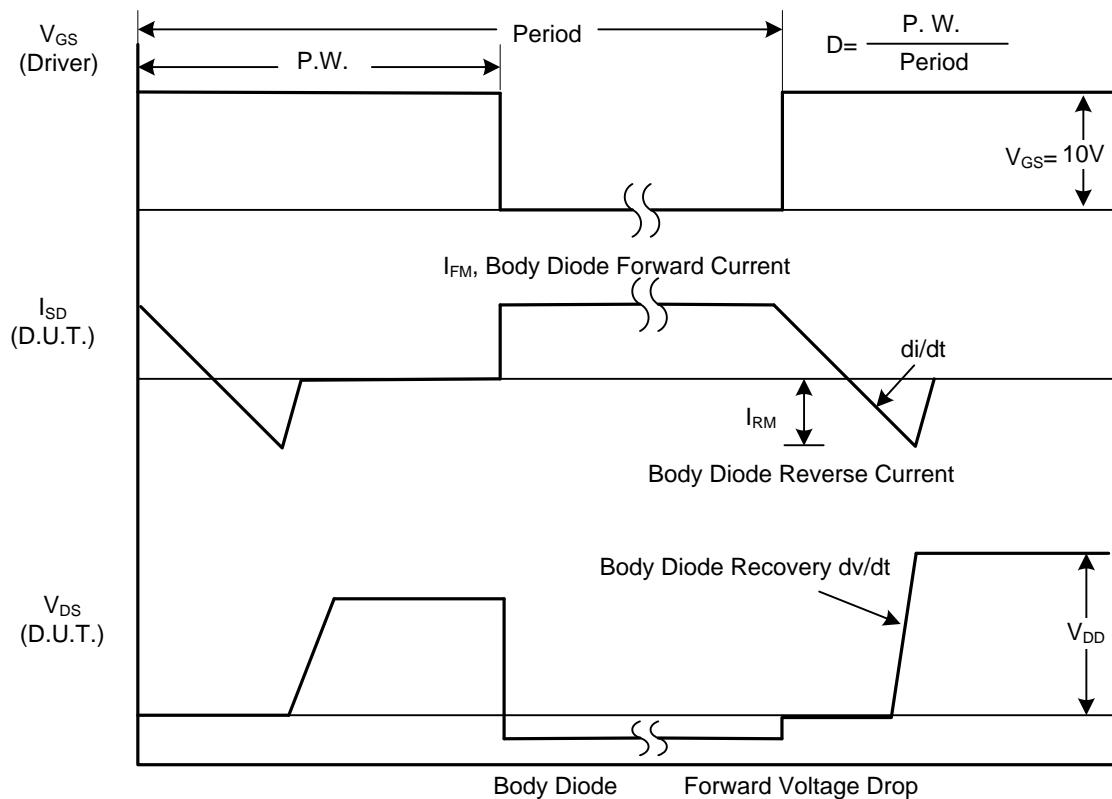
Notes: 1. Pulse Test : Pulse width $\leq 300\mu\text{s}$, Duty cycle $\leq 2\%$

2. Essentially independent of operating temperature

■ TEST CIRCUITS AND WAVEFORMS

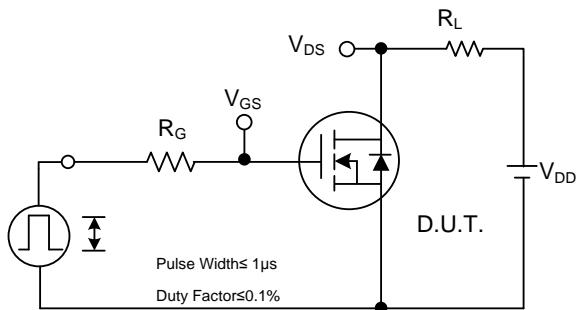


Peak Diode Recovery dv/dt Test Circuit

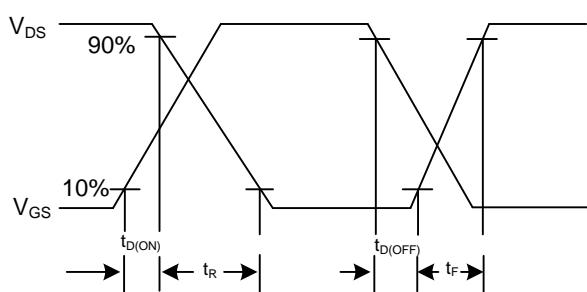


Peak Diode Recovery dv/dt Waveforms

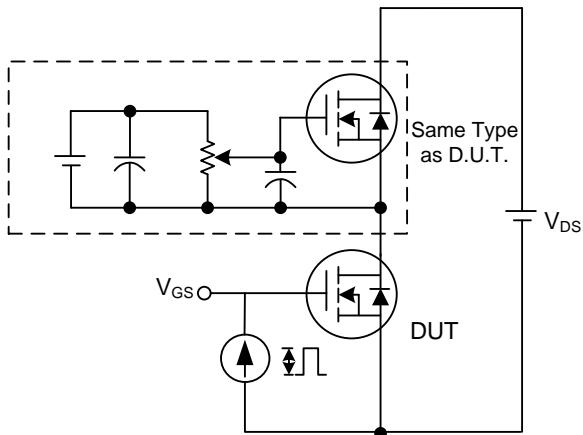
■ TEST CIRCUITS AND WAVEFORMS



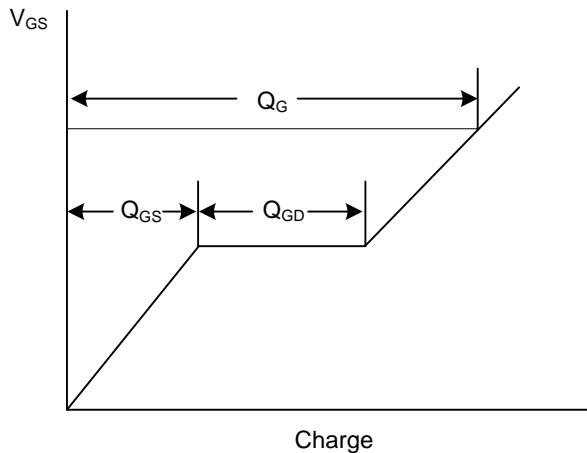
Switching Test Circuit



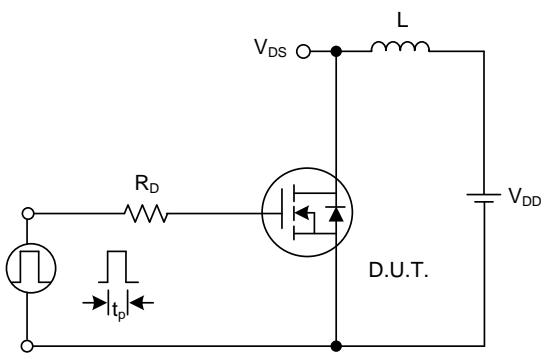
Switching Waveforms



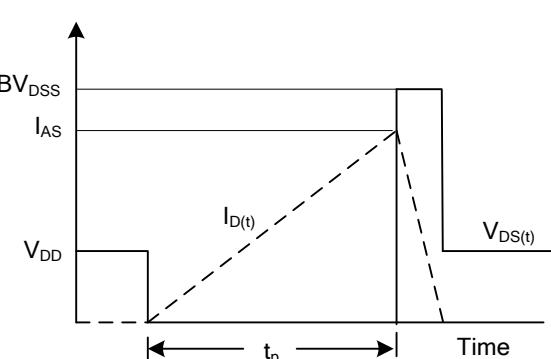
Gate Charge Test Circuit



Gate Charge Waveform

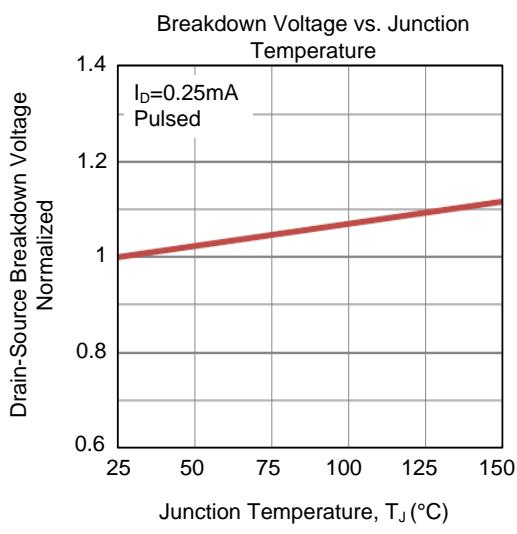
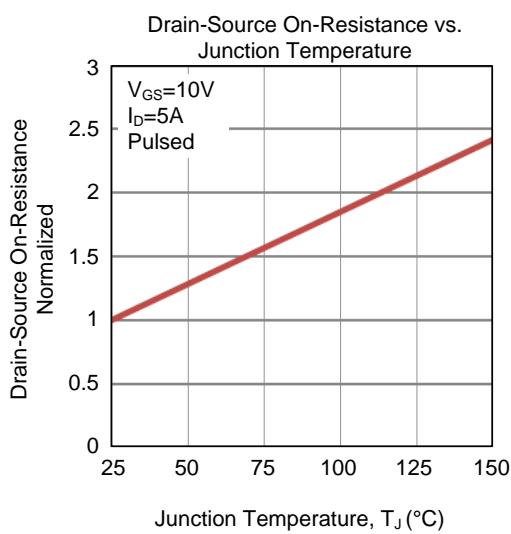
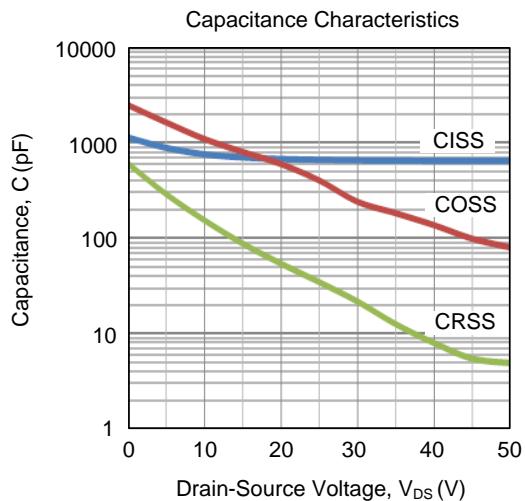
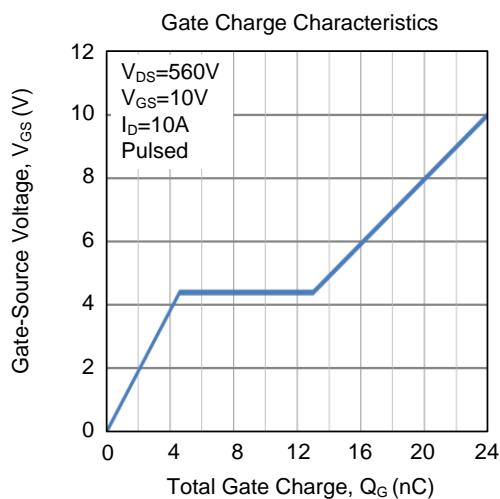
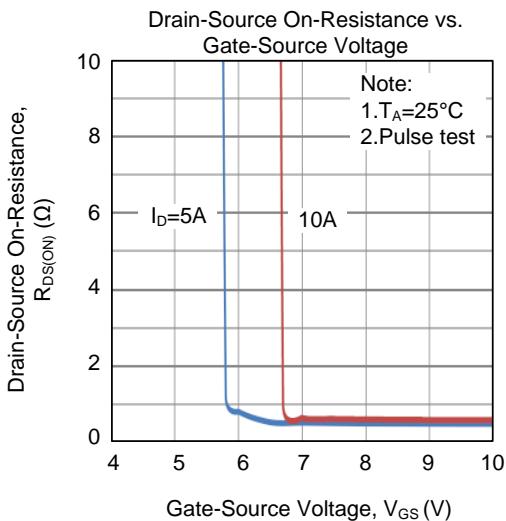
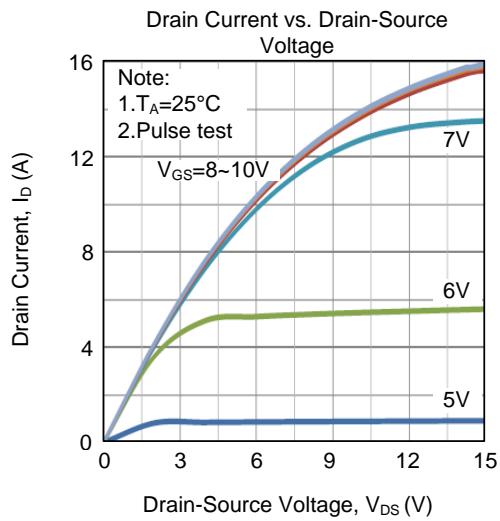


Unclamped Inductive Switching Test Circuit

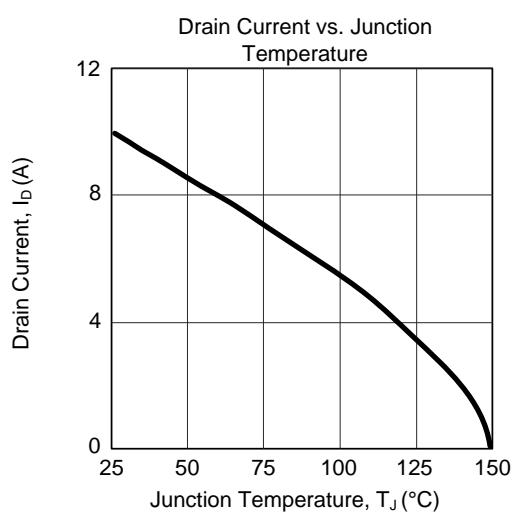
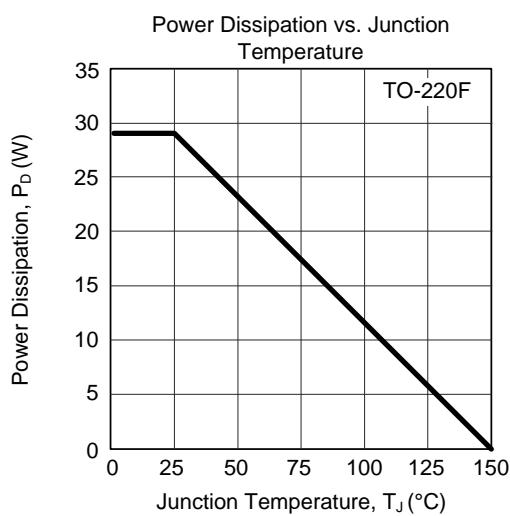
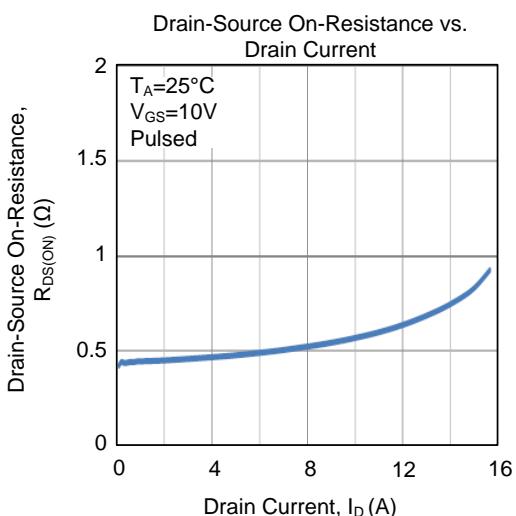
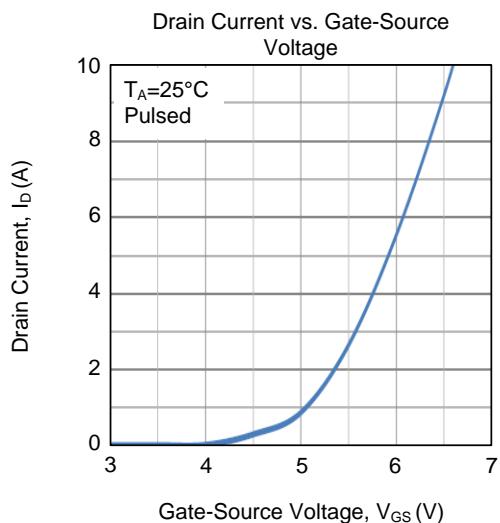
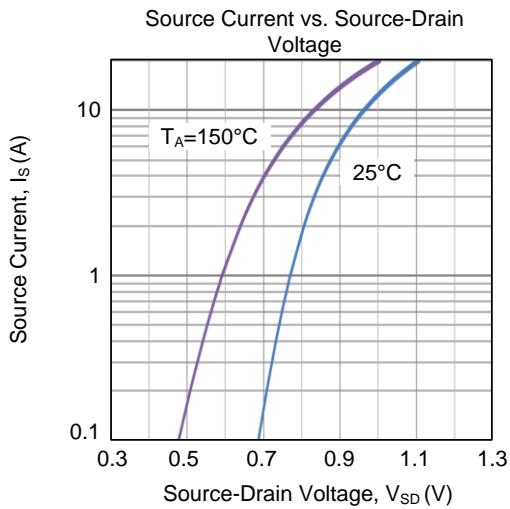
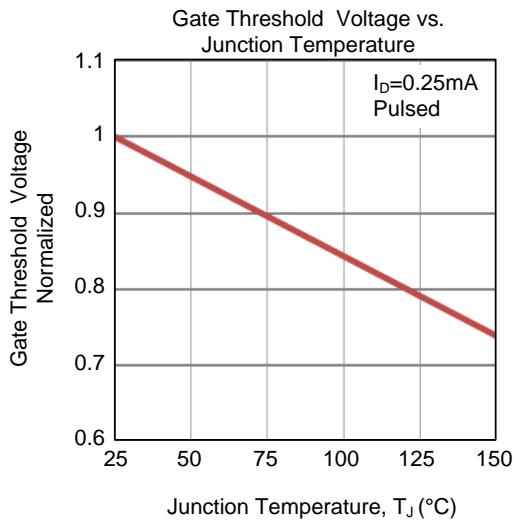


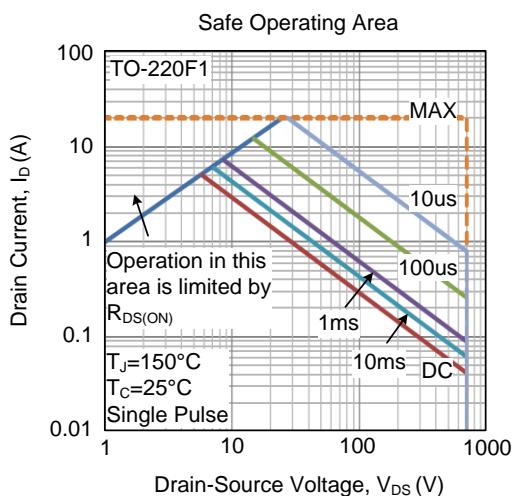
Unclamped Inductive Switching Waveforms

■ TYPICAL CHARACTERISTICS



■ TYPICAL CHARACTERISTICS (Cont.)



■ TYPICAL CHARACTERISTICS (Cont.)

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